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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

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Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	10MHz
Connectivity	-
Peripherals	PWM, WDT
Number of I/O	13
Program Memory Size	1KB (1K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8e00110hsc00tr

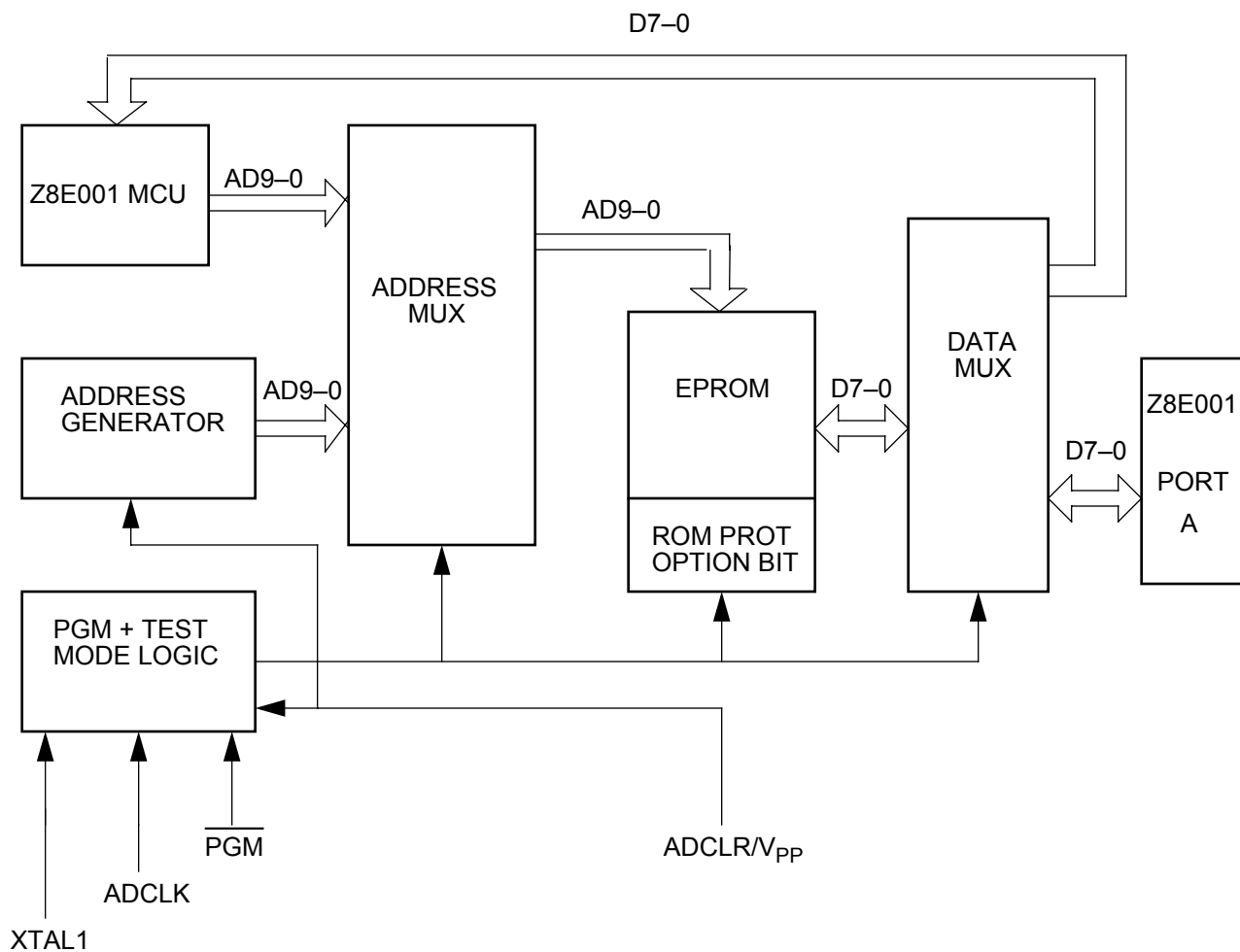


Figure 2. EPROM Programming Mode Block Diagram

PIN DESCRIPTION (Continued)

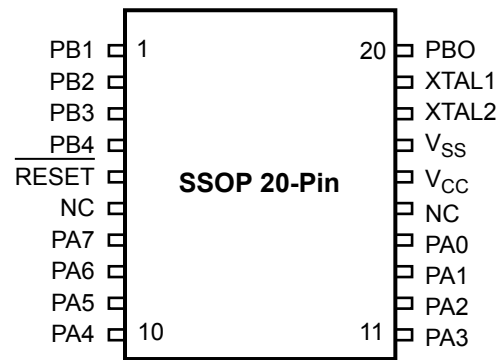


Figure 5. 20-Pin SSOP Pin Identification

Standard Mode			
Pin #	Symbol	Function	Direction
1–4	PB1–PB4	Port B, Pins 1,2,3,4	Input/Output
5	RESET	Reset	Input
6	NC	No Connection	
7–10	PA7–PA4	Port A, Pins 7,6,5,4	Input/Output
11–14	PA3–PA0	Port A, Pins 3,2,1,0	Input/Output
15	NC	No Connection	
16	V _{CC}	Power Supply	
17	V _{SS}	Ground	
18	XTAL2	Crystal Osc. Clock	Output
19	XTAL1	Crystal Osc. Clock	Input
20	PB0	Port B, Pin 0	Input/Output

STANDARD TEST CONDITIONS

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to Ground. Positive current flows into the referenced pin (Figure 7).

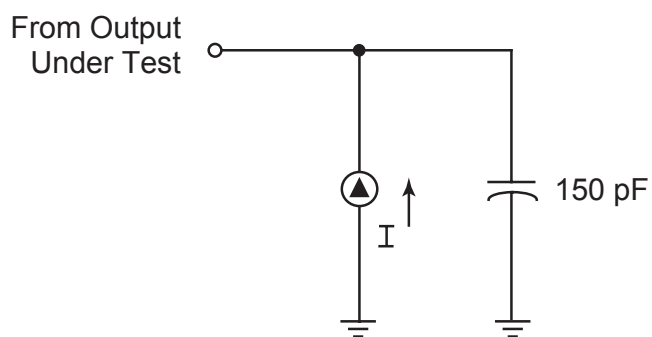


Figure 7. Test Load Diagram

CAPACITANCE

$T_A = 25^\circ\text{C}$, $V_{CC} = \text{GND} = 0\text{V}$, $f = 1.0\text{ MHz}$, unmeasured pins returned to GND.

Parameter	Min	Max
Input capacitance	0	12 pF
Output capacitance	0	12 pF
I/O capacitance	0	12 pF

DC ELECTRICAL CHARACTERISTICS (Continued)

Table 2. DC Electrical Characteristics

T_A = –40°C to +105°C								
Extended Temperatures								
Sym	Parameter	V_{CC}¹	Min	Max	Typical² @ 25°C	Units	Conditions	Notes
V _{CH}	Clock Input High Voltage	4.5V	0.7 V _{CC}	V _{CC} +0.3	2.5	V	Driven by External Clock Generator	
		5.5V	0.7 V _{CC}	V _{CC} +0.3	2.5	V	Driven by External Clock Generator	
V _{CL}	Clock Input Low Voltage	4.5V	V _{SS} –0.3	0.2 V _{CC}	1.5	V	Driven by External Clock Generator	
		5.5V	V _{SS} –0.3	0.2 V _{CC}	1.5	V	Driven by External Clock Generator	
V _{IH}	Input High Voltage	4.5V	0.7 V _{CC}	V _{CC} +0.3	2.5	V		
		5.5V	0.7 V _{CC}	V _{CC} +0.3	2.5	V		
V _{IL}	Input Low Voltage	4.5V	V _{SS} –0.3	0.2 V _{CC}	1.5	V		
		5.5V	V _{SS} –0.3	0.2 V _{CC}	1.5	V		
V _{OH}	Output High Voltage	4.5V	V _{CC} –0.4		4.8	V	I _{OH} = –2.0 mA	
		5.5V	V _{CC} –0.4		4.8	V	I _{OH} = –2.0 mA	
V _{OL1}	Output Low Voltage	4.5V		0.4	0.1	V	I _{OL} = +4.0 mA	
		5.5V		0.4	0.1	V	I _{OL} = +4.0 mA	
V _{OL2}	Output Low Voltage	4.5V		1.2	0.5	V	I _{OL} = +12 mA	
		5.5V		1.2	0.5	V	I _{OL} = +12 mA	
V _{RH}	Reset Input High Voltage	4.5V	0.5V _{CC}	V _{CC}	1.1	V		
		5.5V	0.5V _{CC}	V _{CC}	2.2	V		
V _{OFFSET}	Comparator Input Offset Voltage	4.5V		25.0	10.0	mV		
		5.5V		25.0	10.0	mV		
I _{IL}	Input Leakage	4.5V	–1.0	2.0	<1.0	μA	V _{IN} = 0V, V _{CC}	
		5.5V	–1.0	2.0	<1.0	μA	V _{IN} = 0V, V _{CC}	
I _{OL}	Output Leakage	4.5V	–1.0	2.0	<1.0	μA	V _{IN} = 0V, V _{CC}	
		5.5V	–1.0	2.0	<1.0	μA	V _{IN} = 0V, V _{CC}	
V _{ICR}	Comparator Input Common Mode Voltage Range	4.5V	0	V _{CC} –1.5V		V		3
		5.5V	0	V _{CC} –1.5V		V		3
I _{IR}	Reset Input Current	4.5V	–18	–180	–112	mA		
		5.5V	–18	–180	–112	mA		

Table 2. DC Electrical Characteristics (Continued)

$T_A = -40^{\circ}\text{C to } +105^{\circ}\text{C}$ Extended Temperatures								
Sym	Parameter	V_{CC}^1	Min	Max	Typical ² @ 25°C	Units	Conditions	Notes
I_{CC}	Supply Current	4.5V		7.0	4.0	mA	@ 10 MHz	4,5
		5.5V		7.0	4.0	mA	@ 10 MHz	4,5
I_{CC1}	Standby Current	4.5V		2.0	1.0	mA	HALT Mode $V_{IN} = 0V$, V_{CC} @ 10 MHz	4,5
		5.5V		2.0	1.0	mA	HALT Mode $V_{IN} = 0V$, V_{CC} @ 10 MHz	4,5
I_{CC2}	Standby Current	4.5V		700	250	nA	STOP Mode $V_{IN} = 0V$, V_{CC}	6
		5.5V		700	250	nA	STOP Mode $V_{IN} = 0V$, V_{CC}	6

Notes:

1. The V_{CC} voltage specification of 4.5V and 5.5V guarantees 5.0V $\pm$ 0.5V.
2. Typical values are measured at $V_{CC} = 3.3V$ and $V_{CC} = 5.0V$; $V_{SS} = 0V = GND$.
3. For analog comparator input when analog comparator is enabled.
4. All outputs unloaded and all inputs are at V_{CC} or V_{SS} level.
5. CL1 = CL2 = 22 pF.
6. Same as note 4 except inputs at V_{CC} .

Z8PLUS CORE

The Z8E001 is based on the ZiLOG Z8Plus Core Architecture. This core is capable of addressing up to 64KBytes of program memory and 4KBytes of RAM. Register RAM is accessed as either 8 or 16 bit registers using a combination of 4, 8, and 12 bit addressing modes. The architecture sup-

ports up to 15 vectored interrupts from external and internal sources. The processor decodes 44 CISC instructions using six addressing modes. See the Z8Plus User's Manual for more information.

RESET

This section describes the Z8E001 reset conditions, reset timing, and register initialization procedures. Reset is generated by the Reset Pin, Watch-Dog Timer (WDT), and Stop-Mode Recovery (SMR).

A system reset overrides all other operating conditions and puts the Z8E001 into a known state. To initialize the chip's internal logic, the RESET input must be held Low for at least 30 XTAL clock cycles. The control registers and ports

are reset to their default conditions after a reset from the RESET pin. The control registers and ports are not reset to their default conditions after wakeup from Stop Mode or WDT timeout.

During RESET, the program counter is loaded with 0020H. I/O ports and control registers are configured to their default reset state. Resetting the Z8E001 does not affect the contents of the general-purpose registers.

RESET PIN OPERATION

The Z8E001 hardware RESET pin initializes the control and peripheral registers, as shown in Table 4. Specific reset values are shown by 1 or 0, while bits whose states are unchanged or unknown from Power-Up are indicated by the letter U.

RESET must be held Low until the oscillator stabilizes, for an additional 30 XTAL clock cycles, in order to be sure that the internal reset is complete. The RESET pin has a Schmitt-Trigger input with a trip point. There is no High side protection diode. The user should place an external diode from

RESET to V_{CC} . A pull-up resistor on the RESET pin is approximately 500 K Ω , typical.

Program execution starts 10 XTAL clock cycles after RESET has returned High. The initial instruction fetch is from location 0020H. Figure 9 indicates reset timing.

After a reset, the first routine executed must be one that initializes the TCTLHI control register to the required system configuration, followed by initialization of the remaining control registers.

Table 4. Control and Peripheral Registers

Register (HEX)	Register Name	Bits								Comments
		7	6	5	4	3	2	1	0	
FF	Stack Pointer	0	0	U	U	U	U	U	U	Stack pointer is not affected by RESET
FE	Reserved									
FD	Register Pointer	U	U	U	U	0	0	0	0	Register pointer is not affected by RESET
FC	Flags	U	U	U	U	U	U	*	*	Only WDT & SMR flags are affected by RESET
FB	Interrupt Mask	0	0	0	0	0	0	0	0	All interrupts masked by RESET
FA	Interrupt Request	0	0	0	0	0	0	0	0	All interrupt requests cleared by RESET
F9–F0	Reserved									
EF–E0	Virtual Copy									Virtual Copy of the Current Working Register Set
DF–D8	Reserved									

Table 5. Flag Register Bit D1, D0

D1	D0	Reset Source
0	0	RESET Pin
0	1	SMR Recovery
1	0	WDT Reset
1	1	Reserved

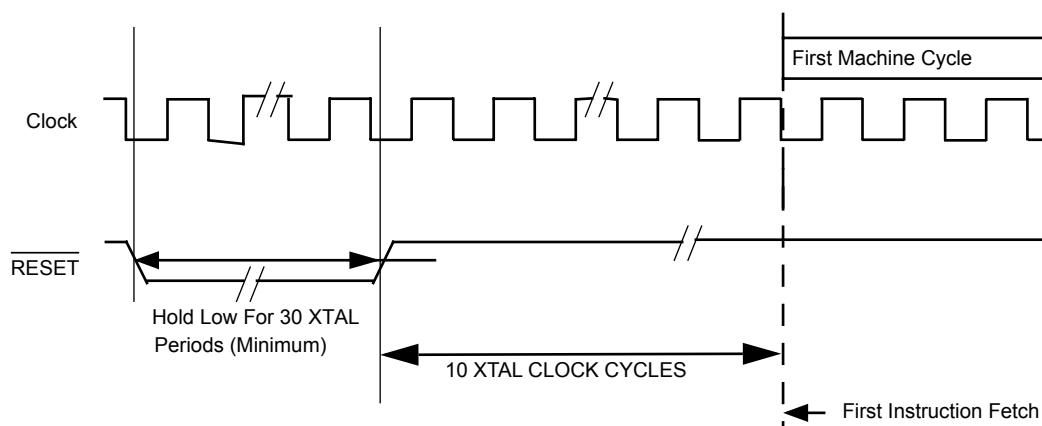


Figure 9. Reset Timing

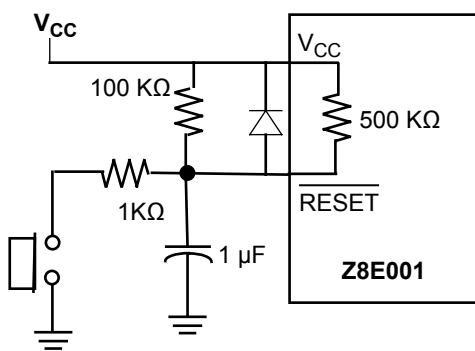


Figure 10. Example of External Power-On Reset (POR) Circuit

RESET PIN OPERATION (Continued)

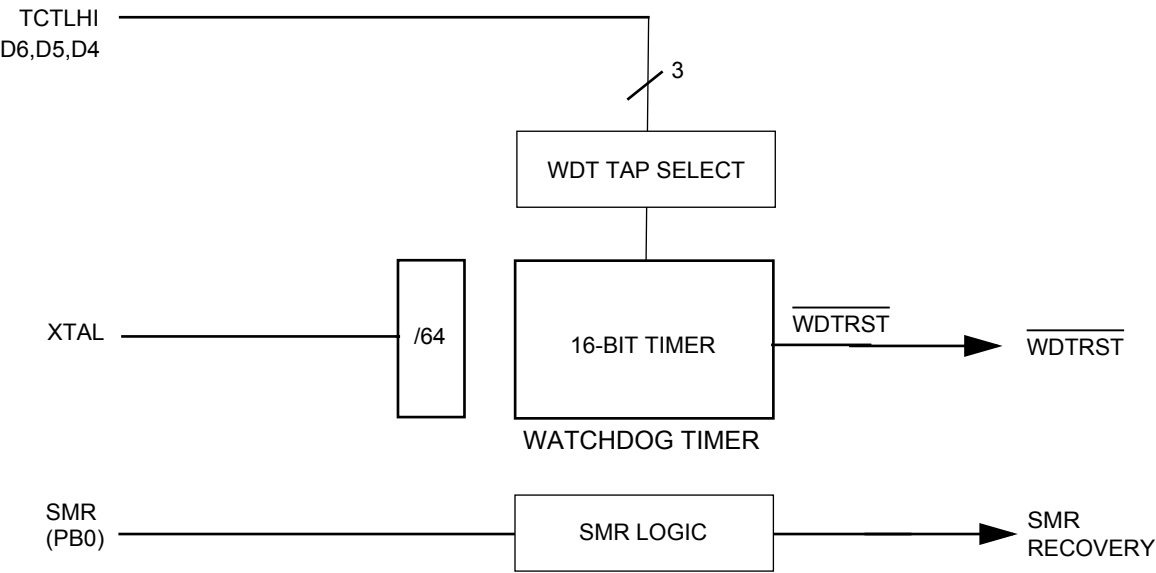


Figure 11. Z8E001 Reset Circuitry with WDT and SMR

Z8E001 WATCH-DOG TIMER (WDT)

The WDT is a retriggerable one-shot 16-bit timer that resets the Z8E001 if it reaches its terminal count. The WDT is driven by the XTAL2 clock pin. To provide the longer timeout periods required in applications, the watchdog timer is only updated every 64th clock cycle. When operating in the RUN or HALT Modes, a WDT timeout reset is functionally equivalent to an interrupt vectoring the PC to 0020H and setting the WDT flag to a one state. Coming out of RESET, the WDT is fully enabled with its timeout value set at the maximum value, unless otherwise programmed during the first instruction. Subsequent executions of the WDT instruction, reinitialize the watchdog timer registers (C2H and C3H), to their initial values as defined by bits D6, D5, and D4 of the TCTLHI register. The WDT cannot be disabled except on the first cycle after RESET, and if the device enters Stop mode.

The WDT instruction should be executed often enough to provide some margin before allowing the WDT registers to

get near 0. Because the WDT timeout periods are relatively long, a WDT reset will occur in the unlikely event that the WDT times out on exactly the same cycle that the WDT instruction is executed.

The WDT and SMR flags are the only flags that are affected by the external RESET pin. RESET clears both the WDT and SMR flags. A WDT timeout sets the WDT flag. The STOP instruction sets the SMR flag. This behavior enables software to determine whether a pin RESET occurred, or whether a WDT timeout occurred, or whether a return from STOP Mode occurred. Reading the WDT and SMR flags does not reset it to zero, the user must clear it via software.

Note: Failure to clear the SMR flag can result in undefined behavior.

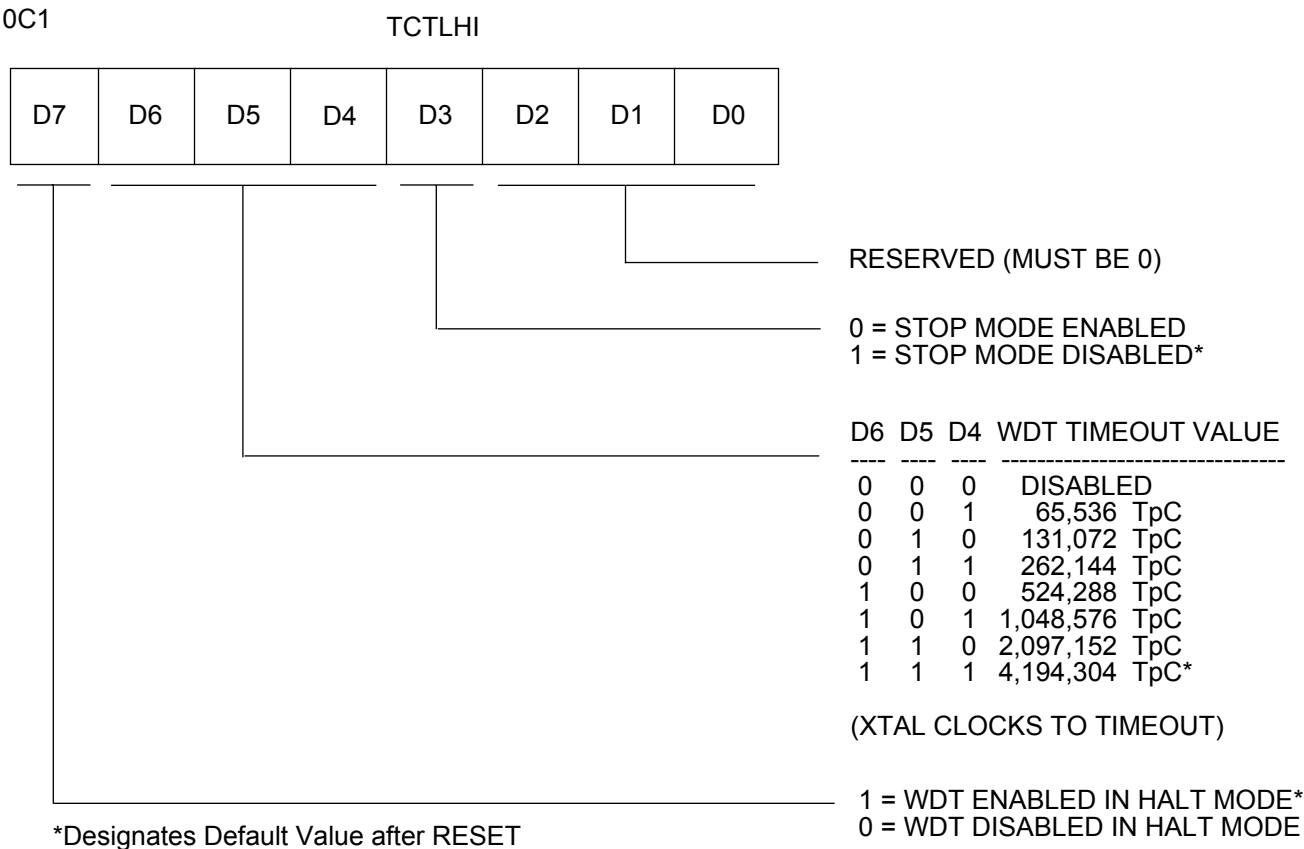


Figure 12. Z8E001 TCTLHI Register for Control of WDT

Note: The WDT can only be disabled via software if the first instruction out of RESET performs this function. Logic within the Z8E001 detects that it is in the process of executing the first instruction after the part leaves RESET. During the execution of this instruction, the upper five bits of the TCTLHI register can be written. After this first instruction, hardware does not allow the upper five bits of this register to be written.

The TCTLHI bits for control of the WDT are described below:

WDT Time Select (D6, D5, D4). Bits 6, 5, and 4 determine the time-out period. Table 6 indicates the range of timeout values that can be obtained. The default values of D6, D5, and D4 are all 1, thus setting the WDT to its maximum time-out period when coming out of RESET.

WDT During HALT (D7). This bit determines whether or not the WDT is active during HALT Mode. A 1 indicates active during HALT. A 0 prevents the WDT from resetting the part while halted. Coming out of reset, the WDT is enabled during HALT Mode.

STOP MODE (D3). Coming out of RESET, the Z8E001 STOP Mode is disabled. If an application requires use of STOP Mode, bit D3 must be cleared immediately upon leaving RESET. If bit D3 is set, the STOP instruction executes as a NOP. If bit D3 is cleared, the STOP instruction enters Stop Mode. Whenever the Z8E001 wakes up after having been in STOP Mode, the STOP Mode is again disabled.

Bits 2, 1 and 0. These bits are reserved and must be 0.

Table 6. WDT Time-Out

D6	D5	D4	Crystal Clocks* to Timeout	Time-Out Using a 10 MHZ Crystal
0	0	0	Disabled	Disabled
0	0	1	65,536 TpC	6.55 ms
0	1	0	131,072 TpC	13.11 ms
0	1	1	262,144 TpC	26.21 ms
1	0	0	524,288 TpC	52.43 ms
1	0	1	1,048,576 TpC	104.86 ms
1	1	0	2,097,152 TpC	209.72 ms
1	1	1	4,194,304 TpC	419.43 ms

Note:
*TpC=XTAL clock cycle. The default on reset is D6=D5=D4=1.

POWER-DOWN MODES

In addition to the standard RUN mode, the Z8E001 MCU supports two Power-Down modes to minimize device current consumption. The two modes supported are HALT and STOP.

HALT MODE OPERATION

The HALT Mode suspends instruction execution and turns off the internal CPU clock. The on-chip oscillator circuit remains active so the internal clock continues to run and is applied to the timers and interrupt logic.

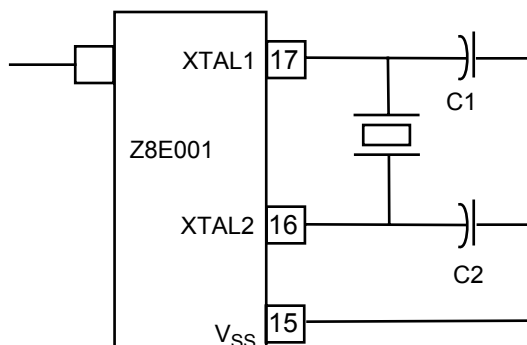
To enter the HALT Mode, the Z8E001 only requires a HALT instruction. It is NOT necessary to execute a NOP instruction immediately before the HALT instruction.

```
7F    HALT    ; enter HALT Mode
```

The HALT Mode can be exited by servicing an interrupt (either externally or internally) generated. Upon completion of the interrupt service routine, the user program continues from the instruction after the HALT instruction.

The HALT Mode can also be exited via a RESET activation or a Watch-Dog Timer (WDT) timeout. In these cases, program execution restarts at the reset restart address 0020H.

- V_{CC} power lines should be separated from the clock oscillator input circuitry.
- Resistivity between XTAL1 or XTAL2 (and the other pins) should be greater than 10 M Ω .



Clock Generator Circuit

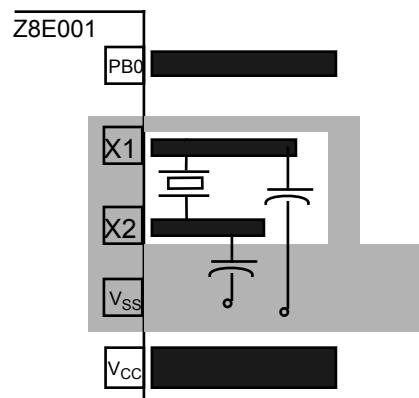
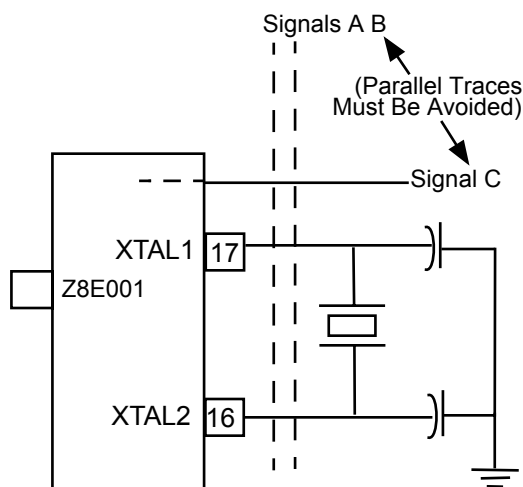
Board Design Example
(Top View)

Figure 15. Circuit Board Design Rules

Crystals and Resonators

Crystals and ceramic resonators (Figure 16) should have the following characteristics to ensure proper oscillation:

Crystal Cut	AT (crystal only)
Mode	Parallel, Fundamental Mode
Crystal Capacitance	<7pF
Load Capacitance	10pF < CL < 220 pF, 15 typical
Resistance	100 ohms max

Depending on the operation frequency, the oscillator can require additional capacitors, C1 and C2, as shown in Figure 16 and Figure 17. The capacitance values are dependent on the manufacturer's crystal specifications.

RESET CONDITIONS

After a hardware RESET, the timers are disabled. See Table 4 for timer control, value, and auto-initialization register status after RESET.

I/O PORTS

The Z8E001 has 13 lines dedicated to input and output. These lines are grouped into two ports known as Port A and Port B. Port A is an 8-bit port, bit programmable as either inputs or outputs. Port B can be programmed to provide standard input/output or the following special functions: timer0 output, comparator input, SMR input, and external interrupt inputs.

All ports have push-pull CMOS outputs. In addition, the outputs of Port A on a bit-wise basis can be configured for open-drain operation. The ports operate on a bit-wise basis. As such, the register values for/at a given bit position only affect the bit in question.

Each port is defined by a set of four control registers. See Figure 27.

Directional Control and Special Function Registers

Each port on the Z8E001 has a dedicated Directional Control Register that determines (on a bit-wise basis) whether a given port bit operates as either an input or an output.

Each port on the Z8E001 has a Special Function Register that, in conjunction with the Directional Control Register, implements (on a bit-wise basis), any special functionality that can be defined for each particular port bit.

READ/WRITE OPERATIONS

The control for each port is done on a bit-wise basis. All bits are capable of operating as inputs or outputs, depending upon the setting of the port's Directional Control Register. If configured as an input, each bit is provided a Schmitt-trigger. The output of the Schmitt-trigger is latched twice to perform a synchronization function, and the output of the synchronizer is fed to the port input register, which can be read by software.

A write to a port input register has the effect of updating the contents of the input register, but subsequent reads do not necessarily return the same value that was written. If the bit in question is defined as an input, the input register for

Table 7. Z8E001 I/O Ports Registers

Register	Address	Identifier
Port B Special Function	0D7H	PTBSFR
Port B Directional Control	0D6H	PTBDIR
Port B Output Value	0D5H	PTBOUT
Port B Input Value	0D4H	PTBIN
Port A Special Function	0D3H	PTASFR
Port A Directional Control	0D2H	PTADIR
Port A Output Value	0D1H	PTAOUT
Port A Input Value	0D0H	PTAIN

Input and Output Value Registers

Each port has an Output Value Register and a pF Input Value Register. For port bits configured as an input by means of the Directional Control Register, the Input Value Register for that bit position contains the current synchronized input value.

For port bits configured as an output by means of the Directional Control Register, the value held in the corresponding bit of the Output Value Register is driven directly onto the output pin. The opposite register bit for a given pin (the output register bit for an input pin and the input register bit for an output pin) holds their previous value. These bits are not changed and don't have any effect on the hardware.

that bit position contains the current synchronized input value. Thus, writes to that bit position is overwritten on the next clock cycle with the newly sampled input data. However, if the particular port bit is programmed as an output, the input register for that bit retains the software-updated value. The port bits that are programmed as outputs do not sample the value being driven out.

Any bit in either port can be defined as an output by setting the appropriate bit in the directional control register. If such is the case, the value held in the appropriate bit of the port output register is driven directly onto the output pin.

PORT B—PIN 0 CONFIGURATION

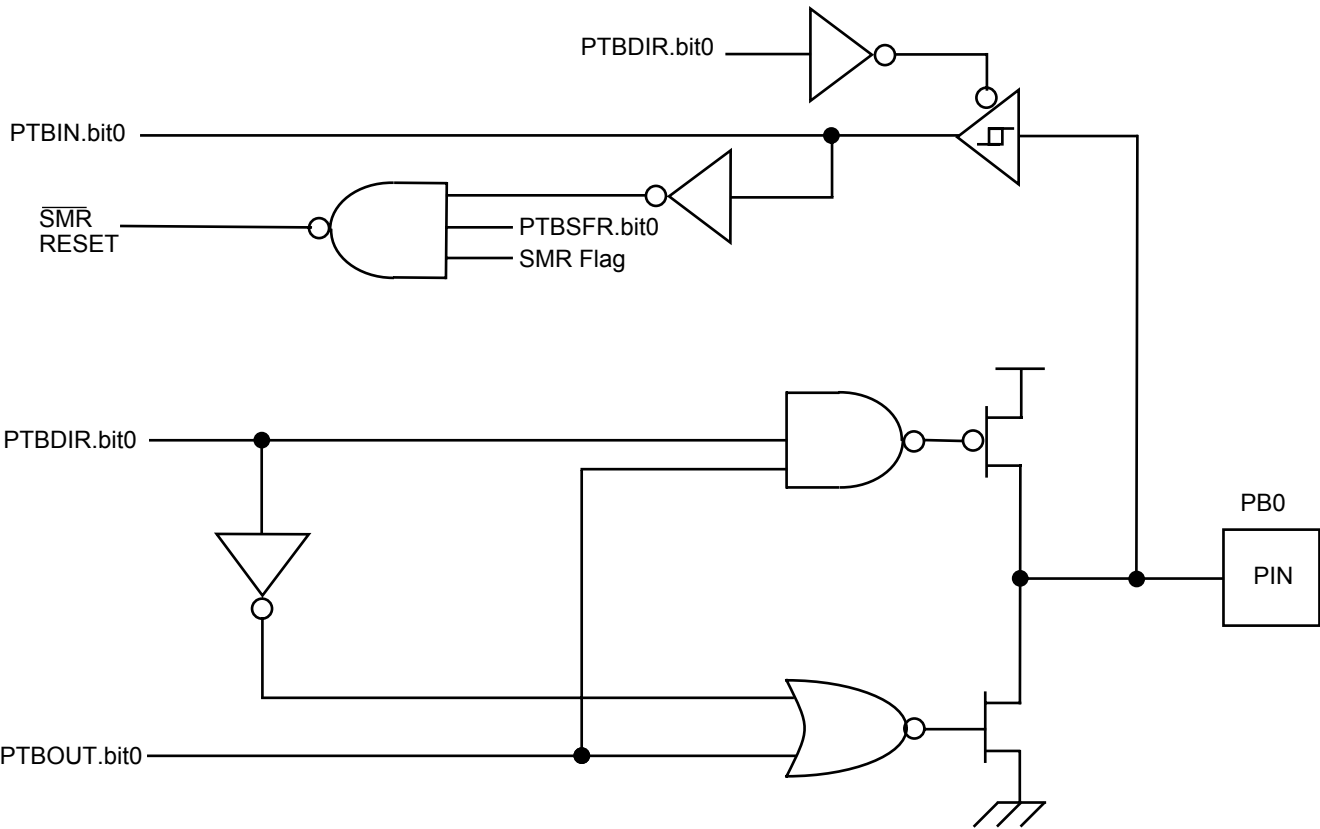


Figure 33. Port B Pin 0 Diagram

PORT B—PIN 1 CONFIGURATION

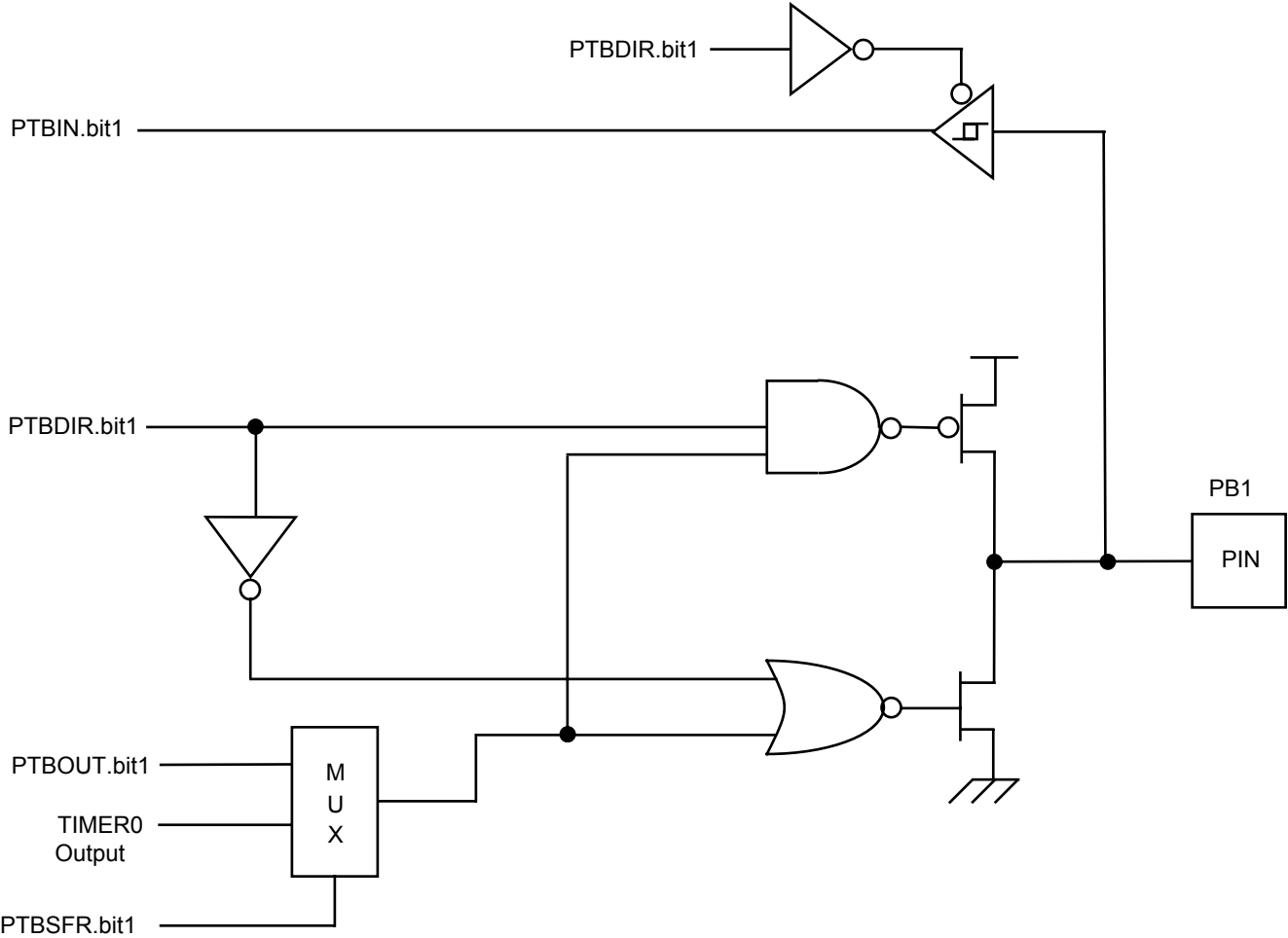


Figure 34. Port B Pin 1 Diagram

PORT B—PINS 3 AND 4 CONFIGURATION

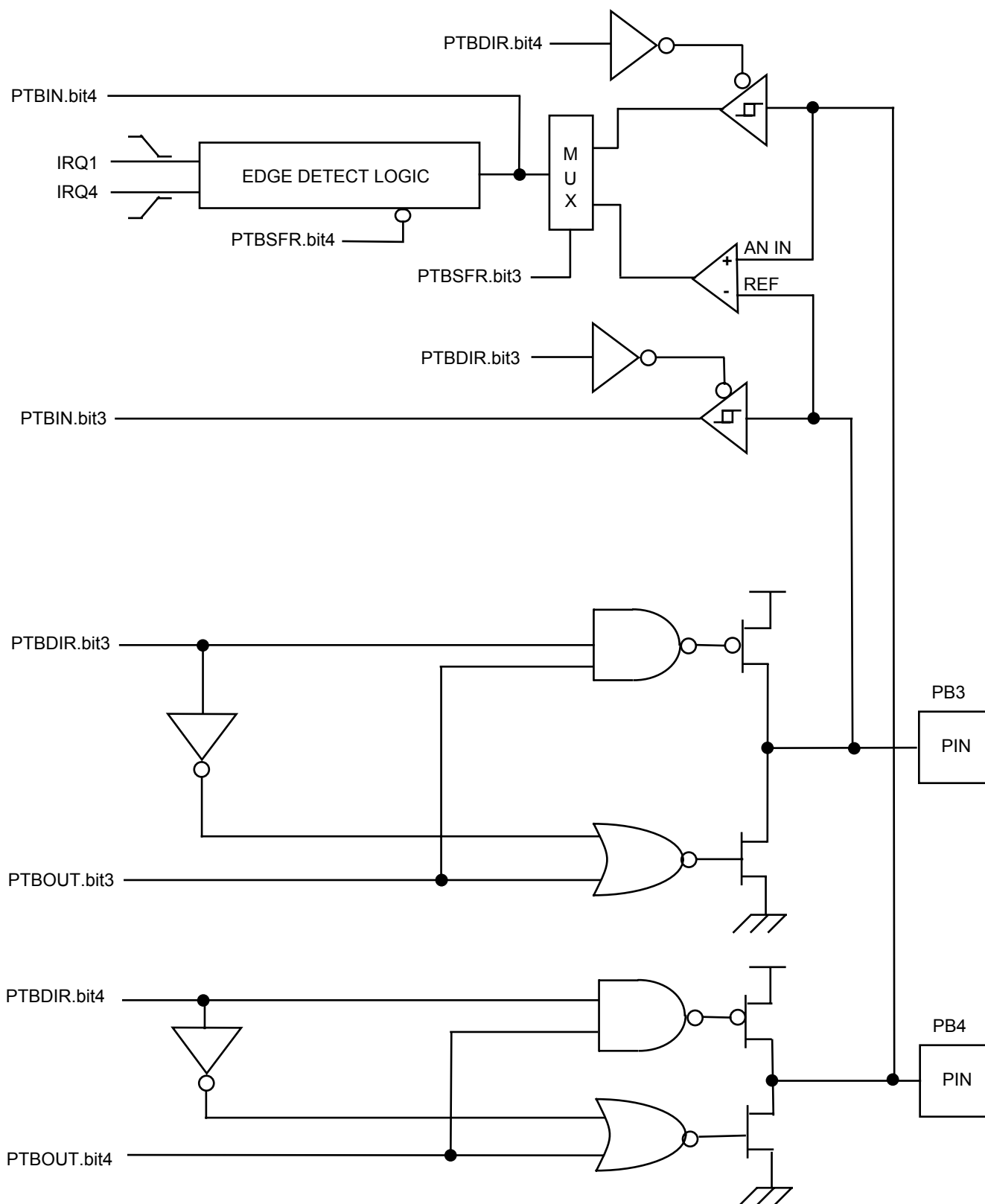


Figure 36. Port B Pins 3 and 4 Diagram

PORT B CONTROL REGISTERS

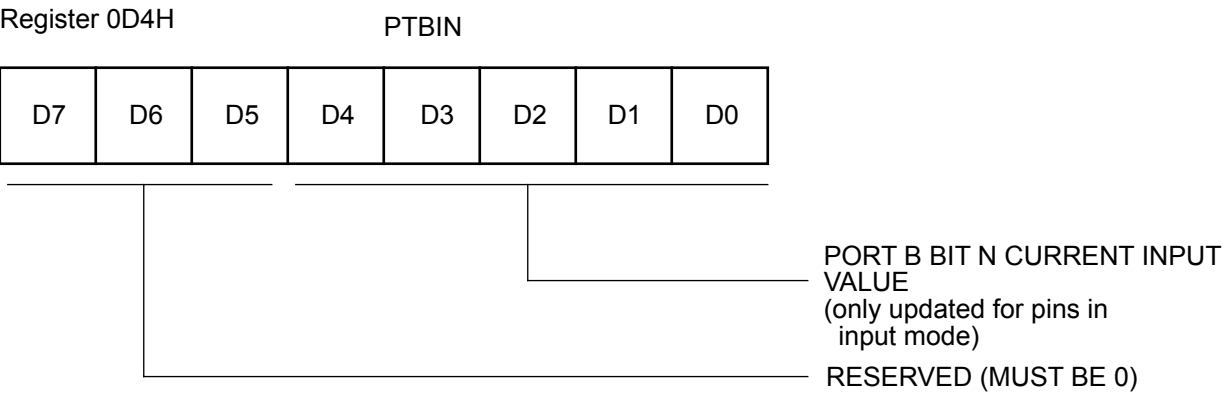


Figure 37. Port B Input Value Register

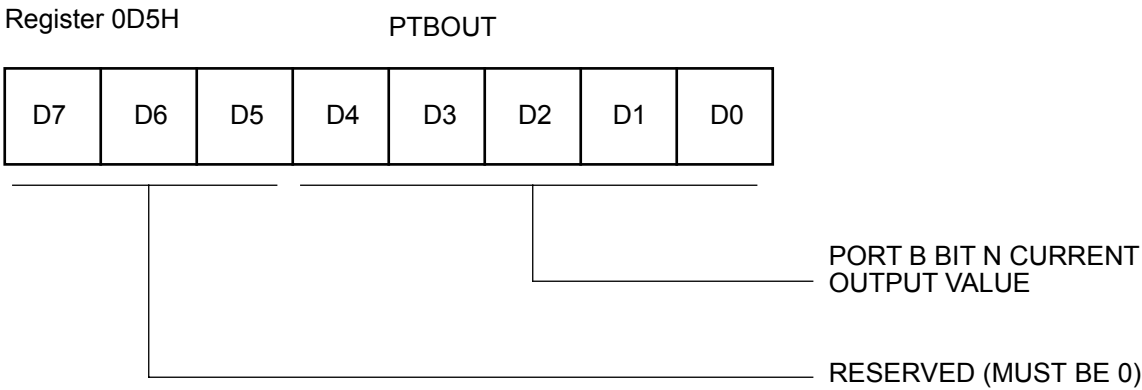


Figure 38. Port B Output Value Register

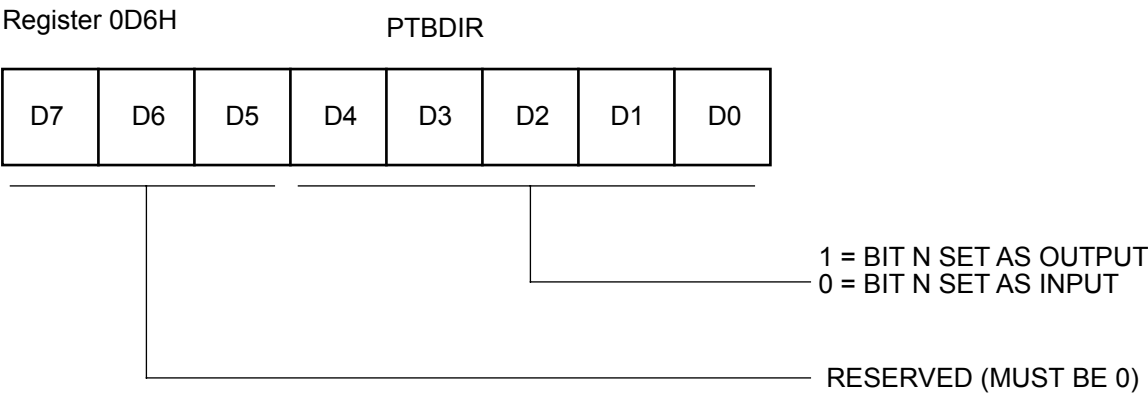


Figure 39. Port B Directional Control Register

PORT B CONTROL REGISTERS (Continued)

Register 0D7H

PTBSFR

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----

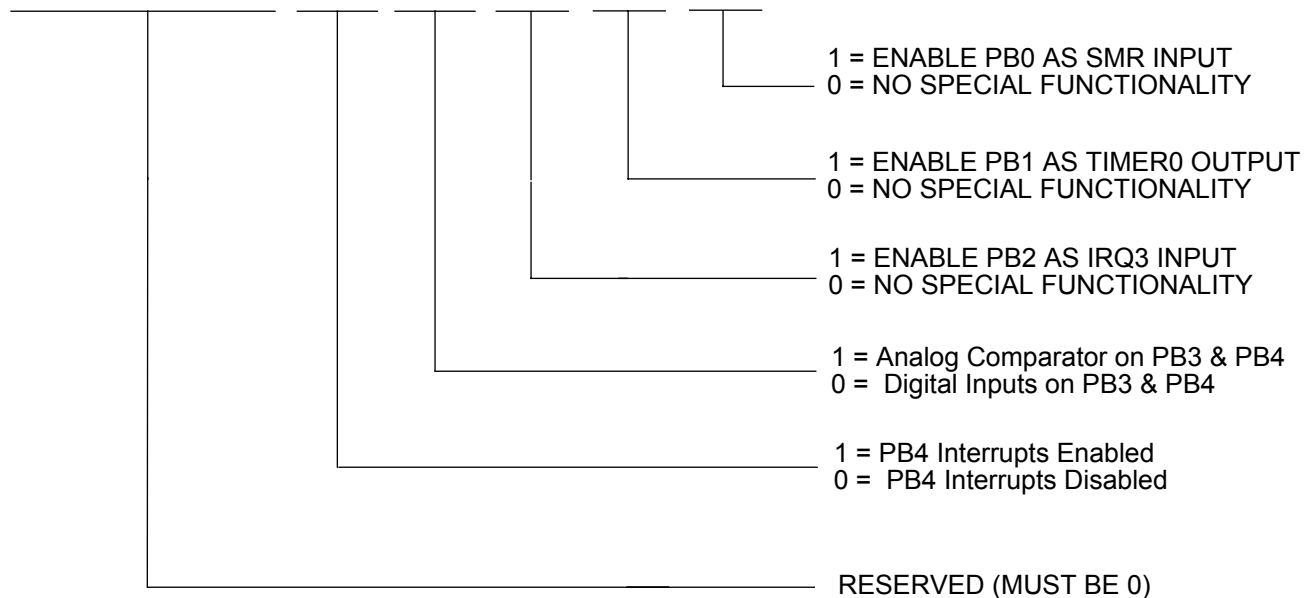


Figure 40. Port B Special Function Register

I/O PORT RESET CONDITIONS

Full Reset

Port A and Port B output value registers are not affected by RESET.

On RESET, the Port A and Port B directional control registers are cleared to all zeros, which defines all pins in both ports as inputs.

On RESET, the directional control registers redefine all pins as inputs, and the Port A and Port B input value registers

overwrites the previously held data with the current sample of the input pins.

On RESET, the Port A and Port B special function registers are cleared to all zeros, which deactivates all port special functions.

Note: The SMR and WDT timeout events are NOT full device resets. The port control registers are not affected by either of these events.

ANALOG COMPARATOR

The Z8E001 includes one on-chip analog comparator. Pin PB4 has a comparator front end. The comparator reference voltage is on pin PB3.

Comparator Description

The on-chip comparator can process an analog signal on PB4 with reference to the voltage on PB3. The analog function is enabled by programming the Port B Special Function Register bits 3 and 4.

When the analog comparator function is enabled, bit 4 of the input register is defined as holding the synchronized output of the comparator, while bit 3 retains a synchronized sample of the reference input.

If the interrupts for PB4 are enabled when the comparator special function is selected, the output of the comparator generates interrupts.

COMPARATOR OPERATION

The comparator output reflects the relationship between the analog input to the reference input. If the voltage on the analog input is higher than the voltage on the reference input, then the comparator output is at a High state. If the voltage on the analog input is lower than the voltage on the reference input, then the analog output will be at a Low state.

Comparator Definitions

V_{ICR}

The usable voltage range for the positive input and reference input is called the common mode voltage range (V_{ICR}).

Note: The comparator is not guaranteed to work if the input is outside of the V_{ICR} range.

V_{OFFSET}

The absolute value of the voltage between the positive input and the reference input required to make the comparator output voltage switch is the input offset voltage (V_{OFFSET}).

I_{IO}

For the CMOS voltage comparator input, the input offset current (I_{IO}) is the leakage current of the CMOS input gate.

HALT Mode

The analog comparator is functional during HALT Mode. If the interrupts are enabled, an interrupt generated by the comparator will cause a return from HALT Mode.

STOP Mode

The analog comparator is disabled during STOP Mode. The comparator is powered down to prevent it from drawing any current.

INPUT PROTECTION

All I/O pins on the Z8E001 have diode input protection. There is a diode from the I/O pad to V_{CC} and V_{SS} (Figure 41).

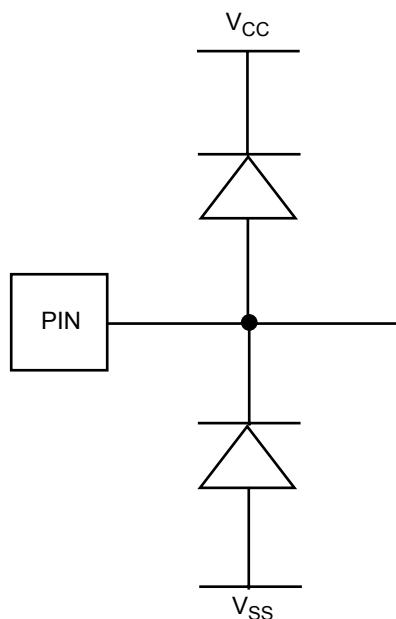


Figure 41. I/O Pin Diode Input Protection

However, on the Z8E001, the RESET pin has only the input protection diode from pad to V_{SS} (Figure 42).

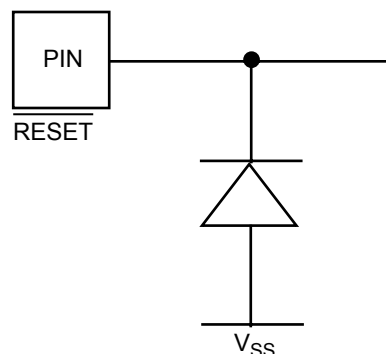
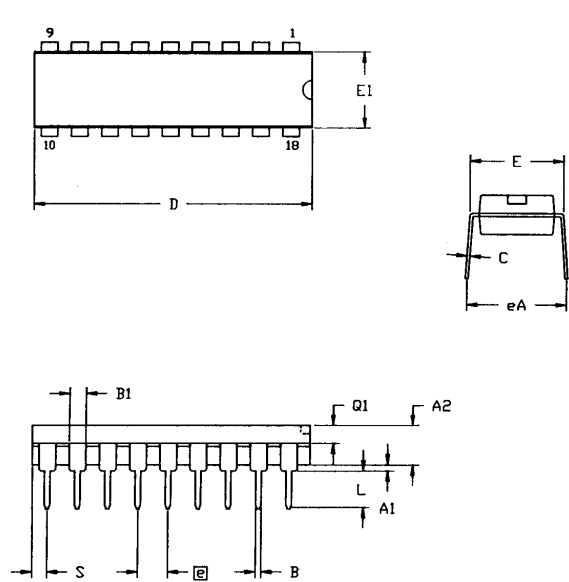


Figure 42. RESET Pin Input Protection

The high-side input protection diode was removed on this pin to allow the application of high voltage during the OTP programming mode.

For better noise immunity in applications that are exposed to system EMI, a clamping diode to V_{CC} from this pin can be required to prevent entering the OTP programming mode or to prevent high voltage from damaging this pin.

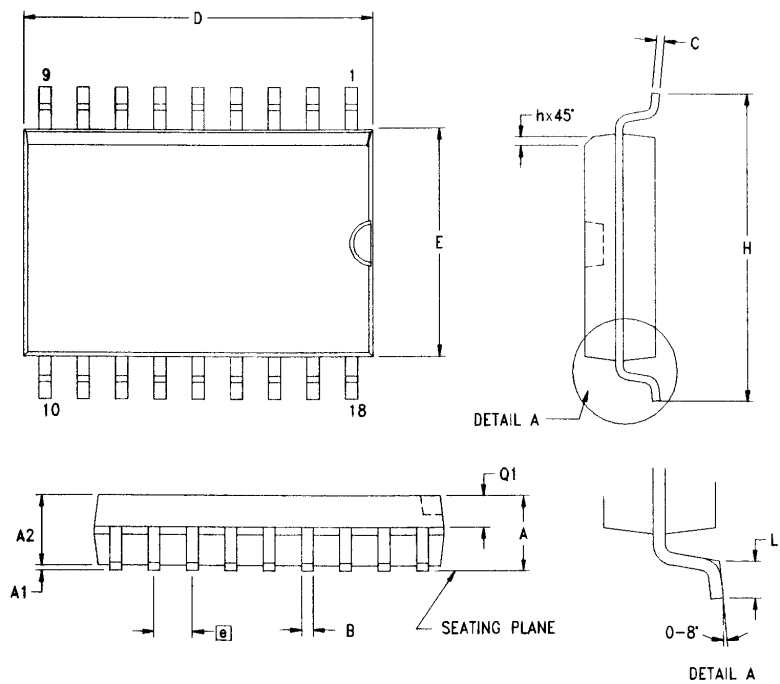
PACKAGE INFORMATION



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A1	0.51	0.81	.020	.032
A2	3.25	3.43	.128	.135
B	0.38	0.53	.015	.021
B1	1.14	1.65	.045	.065
C	0.23	0.38	.009	.015
D	22.35	23.37	.880	.920
E	7.62	8.13	.300	.320
E1	6.22	6.48	.245	.255
⌀	2.54 TYP		.100 TYP	
eA	7.87	8.89	.310	.350
L	3.18	3.81	.125	.150
Q1	1.52	1.65	.060	.065
S	0.89	1.65	.035	.065

CONTROLLING DIMENSIONS : INCH

Figure 43. 18-Pin DIP Package Diagram



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	2.40	2.65	0.094	0.104
A1	0.10	0.30	0.004	0.012
A2	2.24	2.44	0.088	0.096
B	0.36	0.46	0.014	0.018
C	0.23	0.30	0.009	0.012
D	11.40	11.75	0.449	0.463
E	7.40	7.60	0.291	0.299
⌀	1.27 TYP		0.050 TYP	
H	10.00	10.65	0.394	0.419
h	0.30	0.50	0.012	0.020
L	0.60	1.00	0.024	0.039
Q1	0.97	1.07	0.038	0.042

CONTROLLING DIMENSIONS : MM
LEADS ARE COPLANAR WITHIN .004 INCH.

Figure 44. 18-Pin SOIC Package Diagram